PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | | | NEW ASSIGNMENT | | | |
|--|---------------------------|----------|------------------|------------|--|--|
| NATURE OF CONVEYANCE: | | | ASSIGNMENT | | | |
| CONVEYING PARTY DATA | | | | | | |
| Name Execution Date | | | | | | |
| Semiconductor Leading Edge Technologie | | | es, Inc. | 08/01/2005 | | |
| RECEIVING PARTY DATA | | | | | | |
| Name: Fujitsu Limited | | | | | | |
| Street Address: | 1-1, Kamikodanaka 4-chome | | | | | |
| Internal Address: | Nakahara-ku | | | | | |
| City: | Kasasaki-shi, Kanagawa | | | | | |
| State/Country: | JAPAN | | | | | |
| Postal Code: | 211-8588 | | | | | |
| PROPERTY NUMBER | RS Total: 2 | | | | | |
| Property Type | | Number | | | | |
| Application Number: | | 10867735 | | | | |
| Application Number: | | 11013541 | | | | |
| CORRESPONDENCE DATA | | | | | | |
| Fax Number: (202)737-6776 | | | | | | |
| Correspondence will be sent via US Mail when the fax attempt is unsuccessful. | | | | | | |
| Phone: (202) 737-6770 | | | | | | |
| Email: mshakur@leydig.com | | | | | | |
| Correspondent Name: Jeffrey A. Wyand | | | | | | |
| Address Line 1: 700 Thirteenth Street, N. W. | | | | | | |
| Address Line 2: | | | | | | |
| Address Line 4: Washington, DISTRICT OF COLUMBIA 20005 | | | | | | |
| NAME OF SUBMITTER: | | | Jeffrey A. Wyand | | | |
| Total Attachments: 2 source=403318 Takada Assignment 2 properties#page1.tif source=403318 Takada Assignment 2 properties#page2.tif | | | | | | |

500052960

PATENT REEL: 016614 FRAME: 0815

ASSIGNMENT

WHEREAS Semiconductor Leading Edge Technologies, Inc., of 16-1 Onogawa, Tsukuba-shi, Ibaraki, 305-8569, Japan (hereinafter "Assignor") is the owner of the following United States Patent Applications, and the inventions set forth therein, as shown by the records of the United States Patent and Trademark Office:

| U.S. PATENT APPLICATION NO. | FILING DATE |
|-----------------------------------|------------------------------------|
| 10/867,735 11/013,541 | June 16, 2004 December 17, 2004 |
| | |

WHEREAS FUJITSU LIMITED, of 1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi, Kanagawa, 211-8588 Japan (hereinafter referred to as "Assignee") is desirous of acquiring Assignor's entire right, title and interest in and to said inventions for the United States of America, and in and to said United States Patent Applications;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged by Assignor, Assignor has sold, assigned, transferred and sets over, and by these presents hereby sells, assigns, transfers and sets over to Assignee, Assignor's entire and exclusive right, title and interest in and to the Patent Applications for the United States of America listed above, all Letters Patent issuing therefrom, including all continuations, divisions, and extensions thereof, reissues, and reexaminations thereof, all rights, covenants, and obligations under any and all licenses granted for the Patent Applications identified above and all Letters Patent issuing therefrom; and all past, present, and future claims for damages by reason of patent infringement thereof with the right to sue for and collect the same for Assignee's own use, such right, title, and interest to be held and enjoyed by Assignee, its successors and assigns, to the full end of the terms for all Letters Patent issuing from the Patent Applications identified above as fully and entirely as would have been held and enjoyed by Assignor had this Agreement not been made.

Assignor hereby authorizes and requests the U.S. Commissioner of Patents to issue any and all such Letters Patent, reissue patents, and reexamination certificates that may result, to the full extent of Assignor's interest, to said Assignee, its successors or assigns in accordance herewith;

Page 1 of 2

PATENT REEL: 016614 FRAME: 0816 Assignor warrants and covenants that it has the full and unencumbered right to sell and assign the interests herein sold and assigned, and that it has not executed and will not execute any document or instrument in conflict herewith;

Assignor further covenants and agrees that it will communicate to Assignee, its successors, legal representatives or assigns all information known to Assignor relating to said inventions and Patent Applications and that it will, at Assignee's expense, execute and deliver any papers, make all rightful oaths, testify in any legal proceedings, and perform all other lawful acts deemed necessary or desirable by said Assignee, its successors, legal representatives or assigns to perfect title to said Patent Application, or to assist said Assignee, its successors, legal representatives or assigns in obtaining, reissuing or enforcing all such Letters Patent;

The undersigned hereby grant the firm of <u>Leydig</u>, <u>Voit & Mayer</u> the power and authority to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

Semiconductor Leading Edge Technologies, Inc.

Date: August 1,2006

By: Hirond Sakurad
Name: Hiromi SAKURAI
Title: Director, General Manager,
Research Planning Promotion Dept.

Affirmed and Agreed to:

FUJITSU LIMITED

Date: September 6, 2005

RECORDED: 09/30/2005

By: PV V PV

Title: President

Page 2 of 2